Display Elektronik GmbH

DATA SHEET

TFT MODULE

DEM 800480I1 TMH-PW-N

7” TFT

Product Specification Ver.: 3

26.06.2022

Revision History

Revision	Date	Originator	Detail	Remarks
0	27.11.2018	MHI	Initial Release	-
1	10.01.2019	MH	Modify Weight Modify Chromacity Transmissive	P4 P6
2	25.05.2022	LL	Modify Driver IC(Change driver IC name, due to different production line switched from Taiwan to the mainland) Modify AC Characteristics Modify Outline Drawing(B)	P4 P12 P25
3	26.06.2022	MH	Modify Chromacity Transmissive	P4

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	7.0”	-
LCD Type	TN TFT	-
Display Mode	Transmissive / Normally White	-
Resolution	800 x RGB x 480	Pixels
View Direction	12 O’CLOCK	Best Image
Gray Scale Inversion Direction	6 O’CLOCK	-
Module Outline	165.00 x 100.05 x 3.30 (Note1)	mm
Active Area	154.08 x 85.92	mm
Pixel Size	0.1926 x 0.1790	mm
Pixel Arrangement	RGB Vertical Stripe	-
Polarizer Surface Treatment	Anti-Glare	-
Display Colors	16.7 Million	-
Driver IC	EK79713CA & EK73202AB2	-
Interface	24 Bits RGB Interface	-
With or Without Touch Panel	Without	-
Operating Temperature	-20～70	ºC
Storage Temperature	-30～80	ºC
Weight	~116	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25ºC

Item	Symbol	Min.	Max.	Unit
Digital Supply Voltage	DVDD	-0.3	5.0	V
Analog Supply Voltage	AVDD	6.5	13.5	V
Gate On Voltage	VGH	-0.3	40	V
Gate Off Voltage	VGL	-20	0.3	V
Storage Temperature	T_{STG}	-30	+80	ºC
Operating Temperature	T_{OP}	-20	+70	ºC

Note 1: If Ta below 50ºC, the maximal humidity is 90%RH, if Ta over 50ºC, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Digital Supply Voltage	DVDD	3.0	3.3	3.6	V
Analog Supply Voltage	AVDD	10.2	10.4	10.6	V
Gate On Voltage	VGH	15.3	16	16.7	V
Gate Off Voltage	VGL	-7.7	-7.0	-6.3	V
Common Voltage	VCOM	2.6	(3.6)	4.6	V
Logic Input Voltage	V_{IL}	GND	-	0.3*DVDD	V
	V_{IH}	0.7*DVDD	-	DVDD	V

Note: Typical VCOM is only a reference value. It must be optimized according to each LCM. Please use VR.

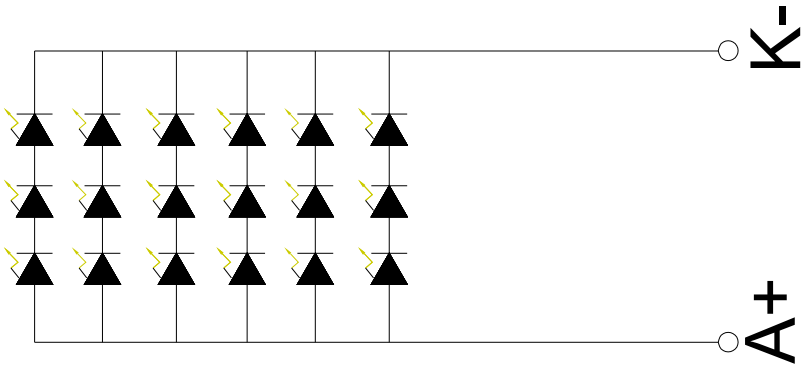
5. Backlight Characteristic

5.1. Backlight Characteristic

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Backlight Voltage	V_{LED}	Ta=25 ºC, I_F=20mA/ LED	8.4	9.6	10.2	V
Backlight Current	I_{LED}	-	-	120	-	mA
Power Dissipation	P_D	-	-	1152	-	mW
Uniformity	Avg	-	-	80	-	%
LED Lifetime (25℃)	-		20,000	30,000	-	Hrs
Drive Method	Constant Current					
LED Configuration	18 White LEDs (3 LEDs in string and 6 groups in parallel)					

Note1：LED life time defined as follows: The final brightness is at 50% of original brightness.
The environmental conducted under ambient air flow, at Ta=25°C±2ºC, 60%RH±5%, I_F=20mA/LED.

5.2. Backlighting Circuit



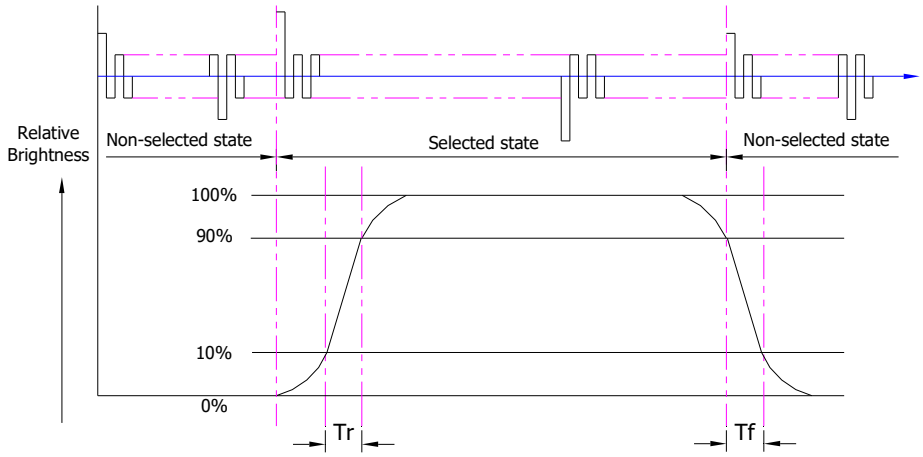
6. Optical Characteristics

6.1. Optical CharacteristicsTa=25ºC, V_{DD} =3.3V

	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
Backlight On (Transmissive Mode)	Luminance on TFT(I_f =20mA/LED)		Lv	Normally viewing angle θX = φY =0º	200	250	-	cd/m²
	Contrast Ratio(See 6.3)		CR		400	500	-	
	Response Time (See 6.2)		TR+TF		-	25	50	ms
	Chromaticity Transmissive (See 6.5)	Red	XR		0.494	0.544	0.594	
			YR		0.277	0.327	0.377	
		Green	XG		0.270	0.320	0.370	
			YG		0.562	0.612	0.662	
		Blue	XB		0.087	0.137	0.187	
			YB		0.021	0.071	0.121	
		White	XW		0.219	0.269	0.319	
			YW		0.255	0.305	0.355	
	Viewing Angle (See 6.4)	Horizontal	θX+	Center CR≥10	60	70	-	Deg.
			θX-		60	70	-	
		Vertical	φY+		40	50	-	
			φY-		60	70	-	
	NTSC				-	50	-	%

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

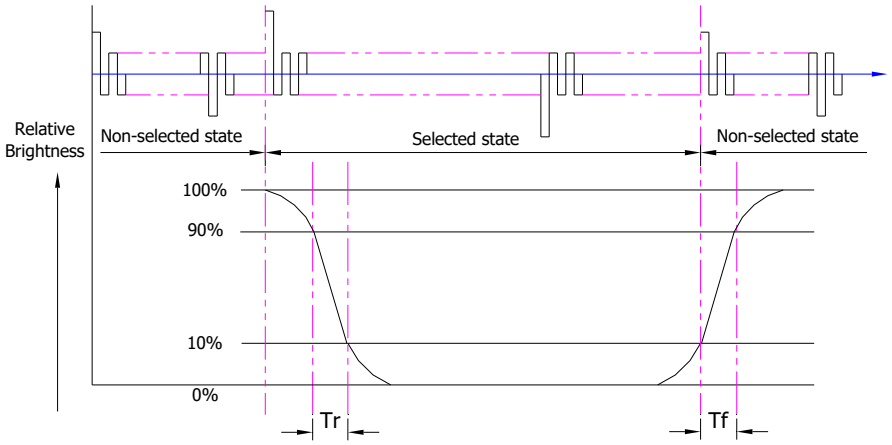


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

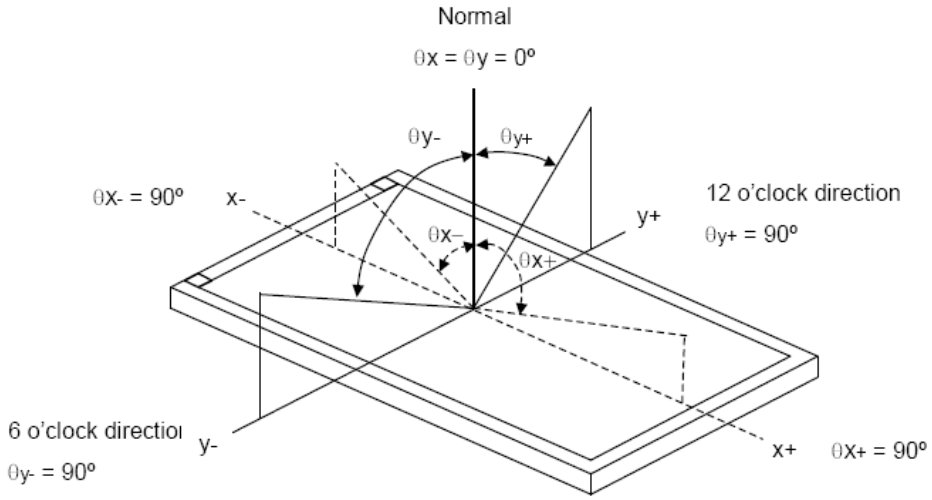
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



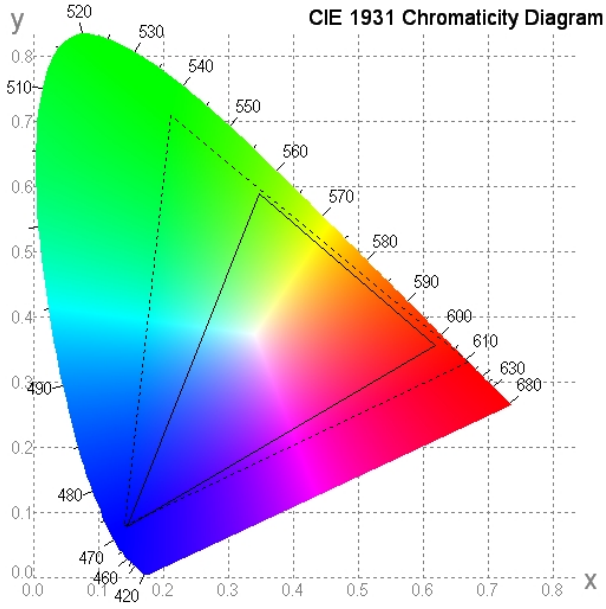
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R, G, B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



6.6. Definition of Surface Luminance, Uniformity and Transmittance

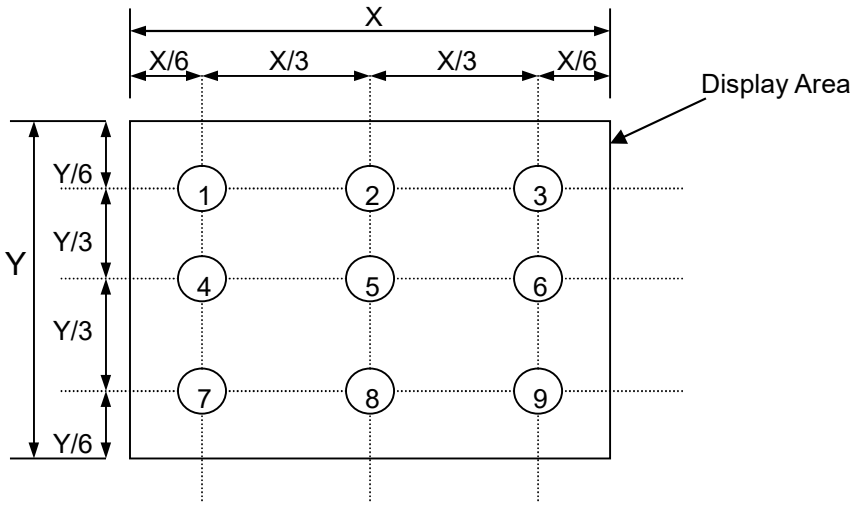
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance: L_V = average (L_{P1}:L_{P9})

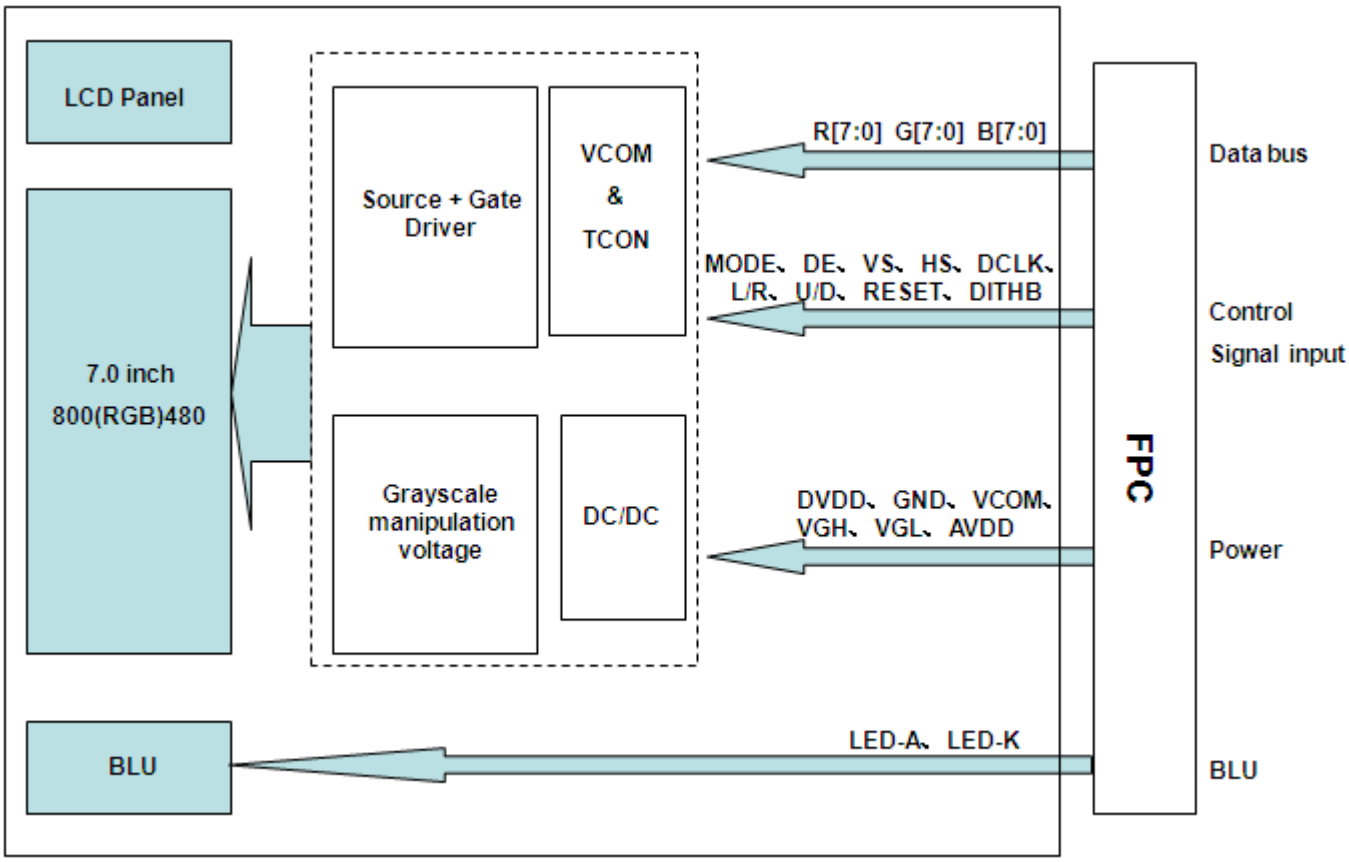
6.6.2. Uniformity = Minimal (L_{P1}:L_{P9}) / Maximal (L_{P1}:L_{P9}) * 100%

6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply



8. Interface Pins Definition

No.	Symbol	Function
1	LED-A	Power for LED backlight (Anode)
2	LED-A	Power for LED backlight (Anode)
3	LED-K	Power for LED backlight (Cathode)
4	LED-K	Power for LED backlight (Cathode)
5	GND	Power ground
6	VCOM	Common voltage
7	DVDD	Digital Power
8	MODE	DE/SYNC mode select. Normally pull high H: DE mode. L: HSD/VSD mode
9	DE	Data Input Enable
10	VS	Vertical sync input. Negative polarity
11	HS	Horizontal sync input. Negative polarity
12	B7	Blue data (MSB)
13	B6	Blue data
14	B5	Blue data
15	B4	Blue data
16	B3	Blue data
17	B2	Blue data
18	B1	Blue data
19	B0	Blue data (LSB)
20	G7	Green data (MSB)
21	G6	Green data
22	G5	Green data
23	G4	Green data
24	G3	Green data
25	G2	Green data
26	G1	Green data
27	G0	Green data (LSB)
28	R7	Red data (MSB)
29	R6	Red data
30	R5	Red data
31	R4	Red data
32	R3	Red data
33	R2	Red data
34	R1	Red data
35	R0	Red data (LSB)
36	GND	Power ground
37	DCLK	Dot data clock
38	GND	Power ground
39	L/R	Left or Right Display Control
40	U/D	Up/Down Display Control

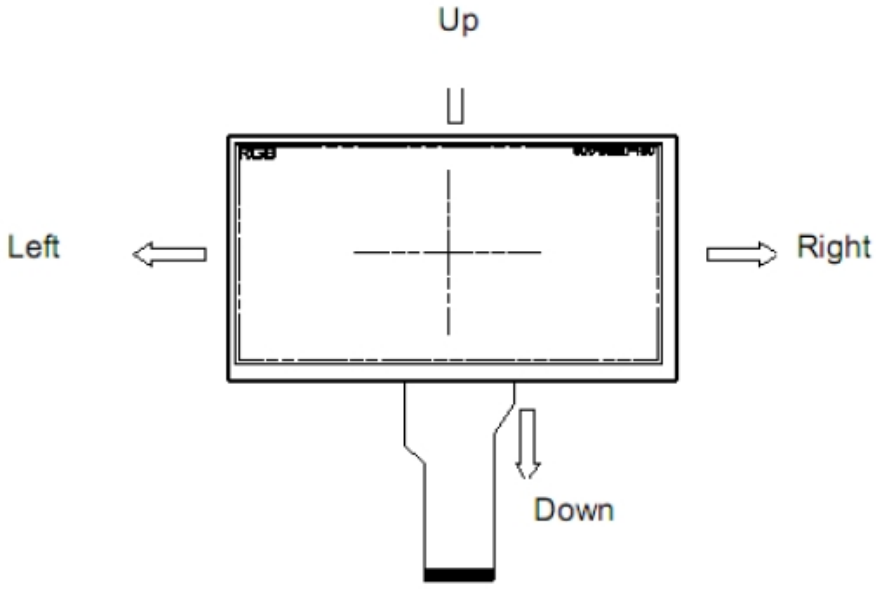
41	VGH	Positive Power for TFT
42	VGL	Negative Power for TFT
43	AVDD	Analog Power
44	RESET	Global reset pin. Active low to enter reset state.
45	NC	No connection
46	VCOM	Common Voltage
47	DITHB	Dithering setting: DITHB=”H” 8 bit resolution (default setting) DITHB=”L” L bit resolution (last 2 bit of input data truncated)
48	GND	Power ground
49	NC	No connection
50	NC	No connection

Note：

Selection of scanning mode

Setting of scan control input		Scanning direction
U/D	L/R	
GND	DV_{DD}	Up to down, left to right
DV_{DD}	GND	Down to up, right to left
GND	GND	Up to down, right to left
DV_{DD}	DV_{DD}	Down to up, left to right

Definition of scanning direction. Refer to the figure as below:



9. Input Signal Timing

1. AC Characteristics

(TA = -20 to 85°C, VDD = 1.8 to 3.6V, AVDD = 6.5 to 13.5V, GND = AVSS = 0V)

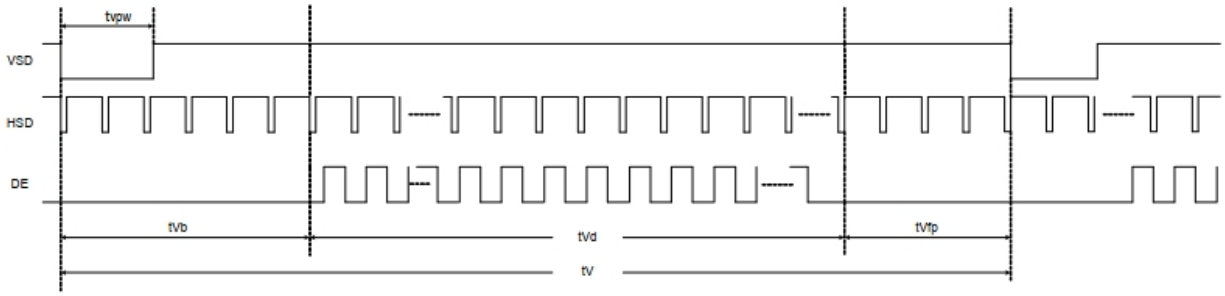
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
VDD Power On Slew rate	TPOR	From 0V to 90% VDD	-	-	20	ms
RSTB pulse width	TRST	CLKIN = 40MHz	1	-	-	ms
CLKIN cycle time	Tcph	-	20	-	-	ns
CLKIN pulse duty	Tcwh	-	40	50	60	%
VSD setup time	Tvst	-	8	-	-	ns
VSD hold time	Tvhd	-	8	-	-	ns
HSD setup time	Thst	-	8	-	-	ns
HSD hold time	Thhd	-	8	-	-	ns
Data set-up time	Tdsu	D0[7:0], D1[7:0], D2[7:0] to CLKIN	8	-	-	ns
Data hold time	Tdhd	D0[7:0], D1[7:0], D2[7:0] to CLKIN	8	-	-	ns
DEN setup time	Tesu	-	8	-	-	ns
DEN hold time	Tehd	-	8	-	-	ns
Output stable time	Tsst	10% to 90% target voltage. CL=120pF, R=10K ohm	-	-	6	us

2. Timing Table

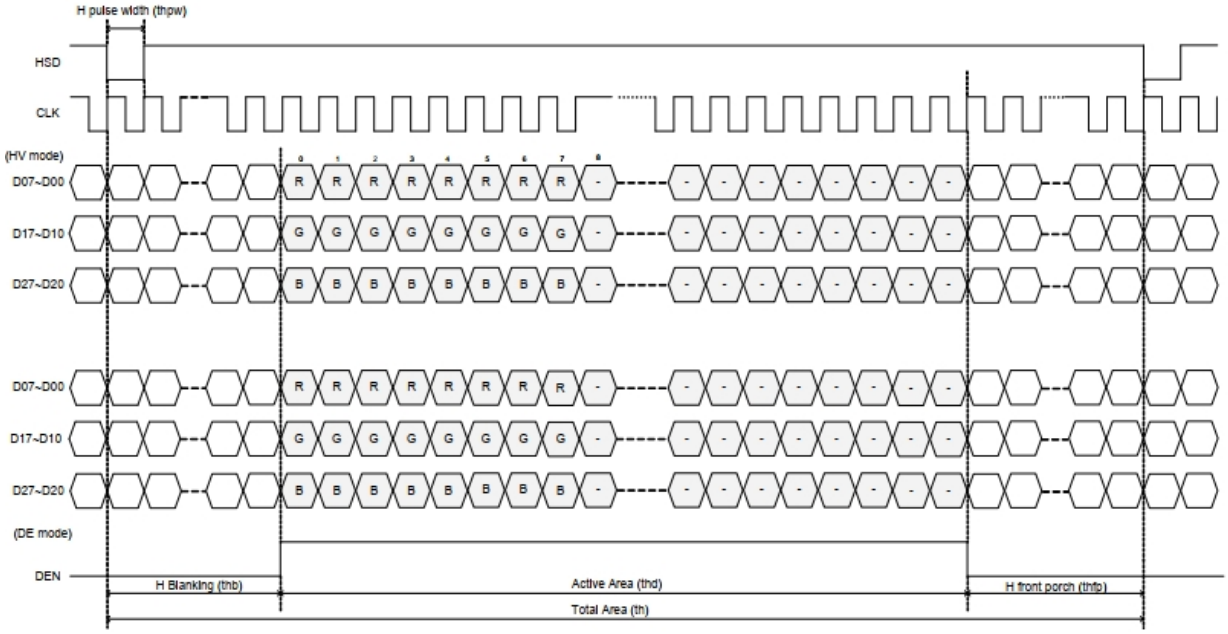
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
CLKIN Frequency	Fclk	VDD = 1.8V ~3.6V	-	33.3	50	MHz
CLKIN Cycle Time	Tclk	-	20	30	-	ns
CLKIN Pulse Duty	Tcwh	Tclk= Tcwh + cwl	40	50	60	%
	Tcwl		40	50	-60	%
VSD to STV	Tstv	HV mode	-	24	-	H
DEN to STV	Tstv	DE mode	-	4	-	CLKIN
STV pulse width	Twstv	-	-	0.5	-	H
STV to CKV	Tckv	-	-	18	-	CLKIN
STV to OEV	Toev	-	-	2	-	CLKIN
CKV Pulse Width	Twckv	-	-	66	-	CLKIN
OEV Pulse Width	Twoev	-	-	50	-	CLKIN

3. Data Input Format

Vertical input timing

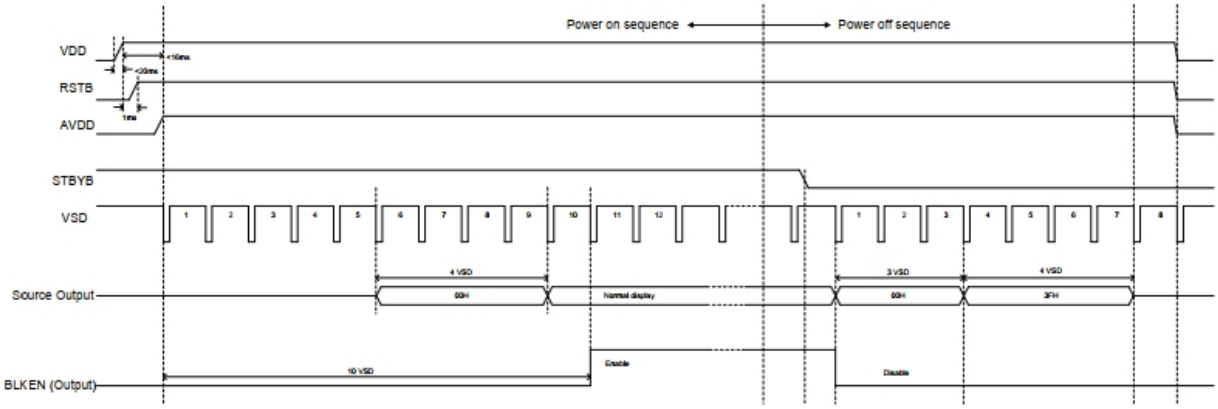


Horizontal input timing

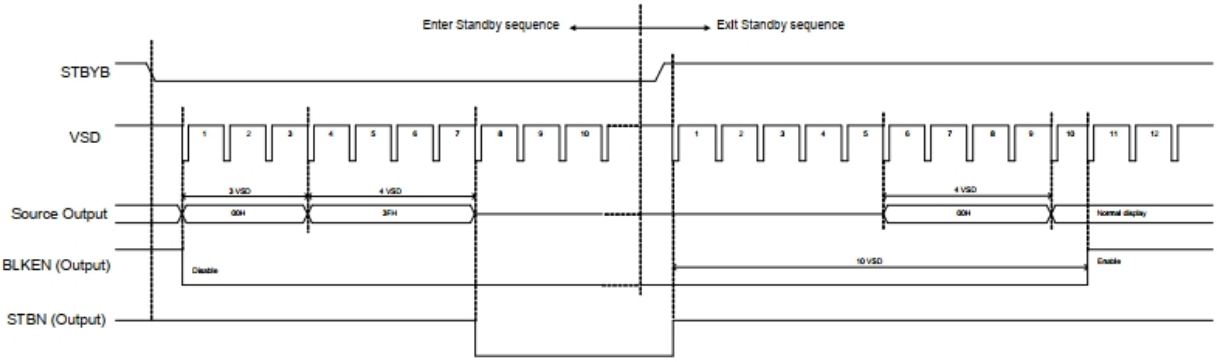


4. Power On/Off Sequence

Power-On/Off Timing Sequence



Enter and Exit Standby Mode Sequence



5. Timing Characteristic

Horizontal input timing

Parameter		Symbol	Value			Unit
Horizontal display area		thd		800		DCLK
DCLK frequency		fclk	Min.	Typ.	Max	
			-	33.3	50	MHz
1 Horizontal Line		th	862	1056	1200	DCLK
HSD pulse width	Min.	thpw		1		
	Typ.			-		
	Max.			40		
HSD Back Porch (Blanking)		thb	46	46	46	
HSD Front Porch		thfp	16	210	354	

Vertical input timing

Parameter	Symbol	Min.	Typ.	Max.	Unit
Vertical display area	tvd		480		H
VSD period time	tv	510	525	650	H
VSD pulse width	tvpw	1	-	20	H
VSD Back Porch (Blanking)	tvb	23	23	23	H
VSD Front Porch	tvfp	7	22	147	H

10. Quality Assurance

10.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2. Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3. Nonconforming Analysis & Disposition

10.3.1. Nonconforming analysis:

10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

10.3.2. Disposition of nonconforming:

10.3.2.1. Non-conforming product over PPM level will be replaced.

10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4. Agreement Items

Shall negotiate with customer if the following situation occurs:

10.4.1. There is any discrepancy in standard of quality assurance.

10.4.2. Additional requirement to be added in product specification.

10.4.3. Any other special problem.

10.5. Standard of the Product Visual Inspection

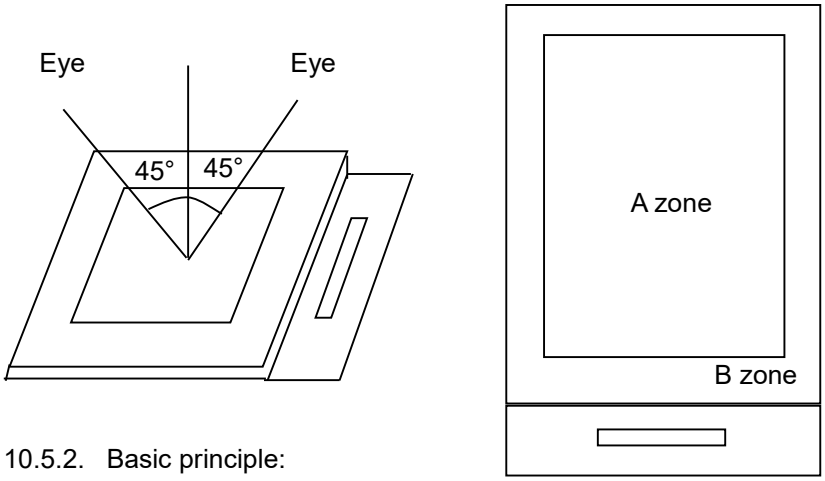
10.5.1. Appearance inspection:

10.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,

10.5.1.4.

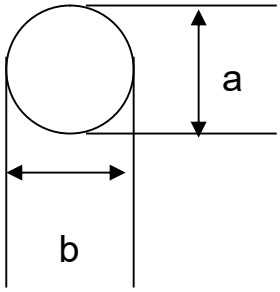


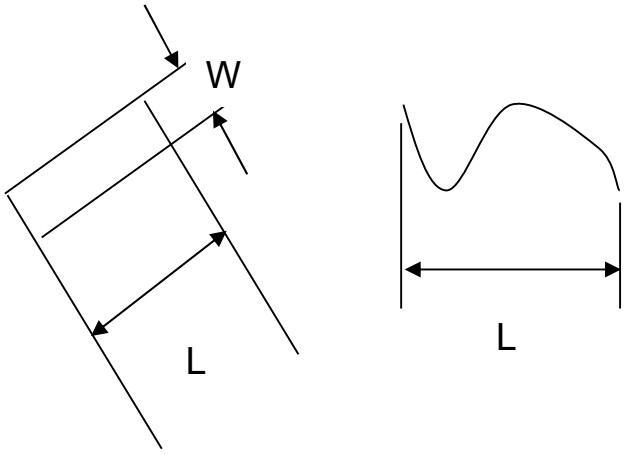
10.5.2. Basic principle:

10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

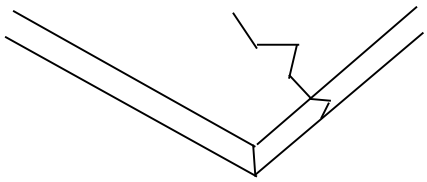
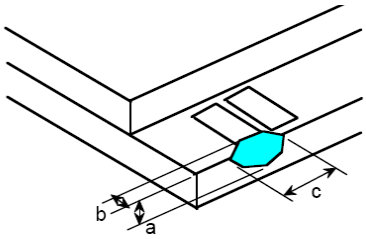
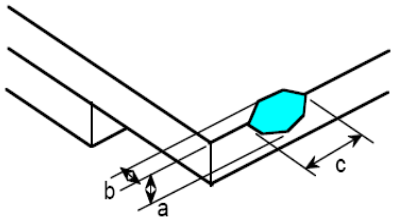
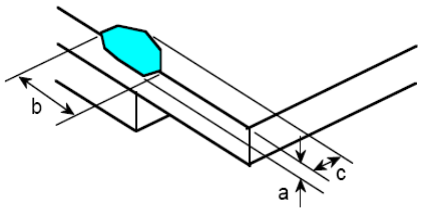
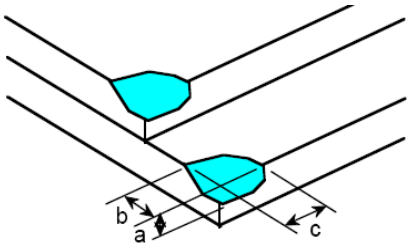
10.5.2.2. New item must be added on time when it is necessary.

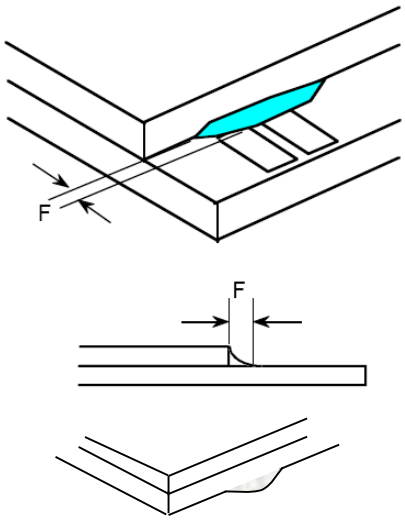
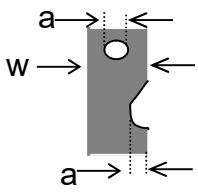
10.6. Inspection Specification

<table>
<tr><th>No.</th><th>Item</th><th>Criteria (Unit: mm)</th></tr>
<tr><td>01</td><td>Black / White spot
Foreign material
(Round type)
Pinholes
Stain
Particles inside cell. (Minor defect)</td><td> 

<table>
<tr><th>Size \ Area</th><th>Acc. Qty</th></tr>
<tr><td>φ≤0.20</td><td>Ignore</td></tr>
<tr><td>0.20<φ≤0.50</td><td>N≤3</td></tr>
<tr><td>0.50<φ</td><td>0</td></tr>
</table>
φ= (a + b) /2
Distance between 2 defects should more than 5mm apart.</td></tr>
<tr><td>02</td><td>Electrical Defect
(Minor defect)</td><td>
<table>
<tr><td rowspan="2">Bright dot</td><td>Display Area</td><td>Total</td><td rowspan="3">Note1</td></tr>
<tr><td>N≤2</td><td>N≤2</td></tr>
<tr><td>Dark dot</td><td>N≤4</td><td>N≤4</td></tr>
<tr><td>Total dot</td><td>N≤4</td><td>N≤4</td><td></td></tr>
<tr><td>Mura</td><td colspan="2">Not visible through 5% ND filters.</td><td>Note2</td></tr>
</table>
Remark:
1. Bright dot caused by scratch and foreign object accords to item 1.</td></tr>
<tr><td>03</td><td>Black and White line
Scratch
Foreign material
(Line type)
(Minor defect)</td><td> 

<table>
<tr><th>Length</th><th>Width</th><th>Acc. Qty</th></tr>
<tr><td>/</td><td>W ≦ 0.1</td><td>Ignore</td></tr>
<tr><td>L ≦ 2.5</td><td>0.1 < W ≦ 0.2</td><td>3</td></tr>
<tr><td>L>2.5</td><td>0.2 < W</td><td>0</td></tr>
<tr><td colspan="2">Total</td><td>3</td></tr>
</table>
Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</td></tr>
</table>

<table>
<tr><td>04</td><td>Glass Crack
(Minor defect)</td><td colspan="2"> 
Crack is potential to enlarge, any type is not allowed.</td></tr>
<tr><td>05</td><td>Glass Chipping Pad Area:
(Minor defect)
  </td><td colspan="2"><table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>c > 3.0, b< 1.0</td><td>1</td></tr><tr><td>c< 3.0, b< 1.0</td><td>3</td></tr><tr><td colspan="2">a<Glass Thickness</td></tr></table></td></tr>
<tr><td>06</td><td>Glass Chipping Rear of Pad Area:
(Minor defect)
  </td><td colspan="2"><table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>c > 3.0, b< 1.0</td><td>1</td></tr><tr><td>c< 3.0, b< 1.0</td><td>2</td></tr><tr><td>c< 3.0, b< 0.5</td><td>4</td></tr><tr><td colspan="2">a<Glass Thickness</td></tr></table></td></tr>
<tr><td>07</td><td>Glass Chipping Except Pad Area:
(Minor defect)
  </td><td colspan="2"><table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>c > 3.0, b< 1.0</td><td>1</td></tr><tr><td>c< 3.0, b< 1.0</td><td>2</td></tr><tr><td>c< 3.0, b< 0.5</td><td>4</td></tr><tr><td colspan="2">a<Glass Thickness</td></tr></table></td></tr>
<tr><td>08</td><td>Glass Corner Chipping:
(Minor defect)
  </td><td colspan="2"><table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>c < 3.0, b< 3.0</td><td>Ignore</td></tr><tr><td colspan="2">a<Glass Thickness</td></tr></table></td></tr>
</table>

<table>
<tr><td>09</td><td>Glass Burr:
(Minor defect)
 
</td><td><table><tr><th>Length</th><th>Acc. Qty</th></tr><tr><td>F < 1.0</td><td>Ignore</td></tr></table>
Glass burr don’t affect assemble and module dimension.</td></tr>
<tr><td>10</td><td>FPC Defect:
(Minor defect)
  </td><td>10.1 Dent, pinhole width a<w/3.
(w: circuitry width.)
10.2 Open circuit is unacceptable.
10.3 No oxidation, contamination and distortion.</td></tr>
<tr><td>11</td><td>Bubble on Polarizer
(Minor defect)</td><td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.30</td><td>Ignore</td></tr><tr><td>0.30 <φ≤0.50</td><td>N≤2</td></tr><tr><td>0.50 < φ</td><td>N=0</td></tr></table></td></tr>
<tr><td>12</td><td>Dent on Polarizer
(Minor defect)</td><td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.25</td><td>Ignore</td></tr><tr><td>0.25 <φ≤0.50</td><td>N≤4</td></tr><tr><td>0.50 < φ</td><td>None</td></tr></table></td></tr>
<tr><td>13</td><td>Bezel</td><td>13.1 No rust, distortion on the Bezel.
13.2 No visible fingerprints, stains or other contamination.</td></tr>
</table>

14	Touch Panel	D: Diameter W: width L: length 14.1 Spot: D<0.25 is acceptable 0.25≤D≤0.4 2dots are acceptable and the distance between defects should more than 10 mm. D>0.4 is unacceptable 14.2 Dent: D>0.40 is unacceptable 14.3 Scratch: W≤0.03, L≤10 is acceptable, 0.03<W≤0.10, L≤10 is acceptable Distance between 2 defects should more than 10 mm. W>0.10 is unacceptable.
15	PCB	15.1 No distortion or contamination on PCB terminals. 15.2 All components on PCB must same as documented on the BOM/component layout. 15.3 Follow IPC-A-600F.
16	Soldering	Follow IPC-A-610C standard
17	Electrical Defect (Major defect)	The below defects must be rejected. 17.1 Missing vertical / horizontal segment, 17.2 Abnormal Display. 17.3 No function or no display. 17.4 Current exceeds product specifications. 17.5 LCD viewing angle defect. 17.6 No Backlight. 17.7 Dark Backlight. 17.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7. Classification of Defects

10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

10.7.2. Two minor defects are equal to one major in lot sampling inspection.

10.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

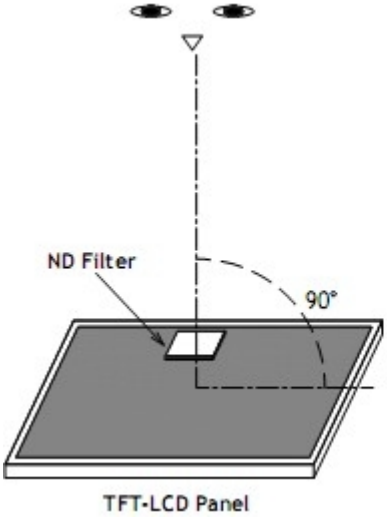
10.9.Packing

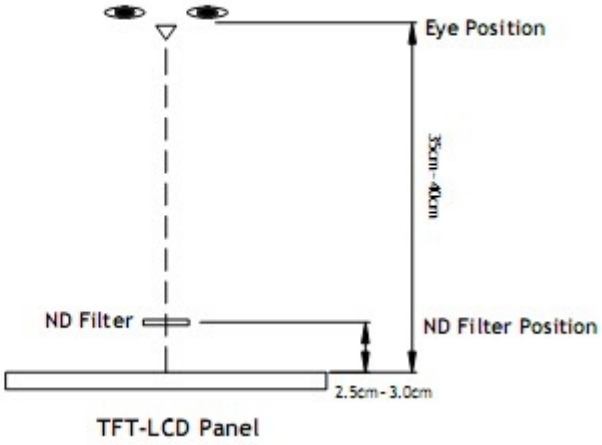
10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.

10.9.2. Modules inside package box should have compliant mark.

10.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.





Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air:±8kV 150pF/330Ω 5 times	2	GB/T17626.2 -2006
		Contact:±4kV 150pF/330Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1. Safety

12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2. Handling

12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.

12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3. Storage

12.3.1. Do not store the LCD module beyond the specified temperature ranges.

12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

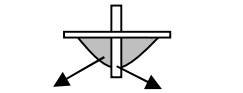
Maximum Solder Temperature: 370℃

Maximum Solder Time: 3s at the maximum temperature

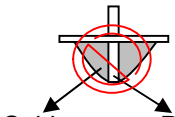
Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



Recommended



Not Recommended

12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270～290℃

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

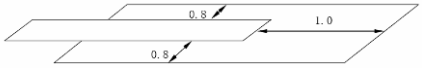
12.4.2.6. Solder Wetting

Recommended Not Recommended

12.4.2.7. The type of the solder iron:

Recommended Not Recommended

12.4.2.8. Solder Pad



12.5. Operation

12.5.1. Do not drive LCD with DC voltage

12.5.2. Response time will increase below lower temperature

12.5.3. Display may change color with different temperature

12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.

12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.

12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.

12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.

12.5.8. Do not display the fixed pattern for long time（we suggest the time not longer than one hour） because it may develop image sticking due to the TFT structure.

12.6. Static Electricity

12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.

12.6.2. The normal static prevention measures should be observed for work clothes and benches.

12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

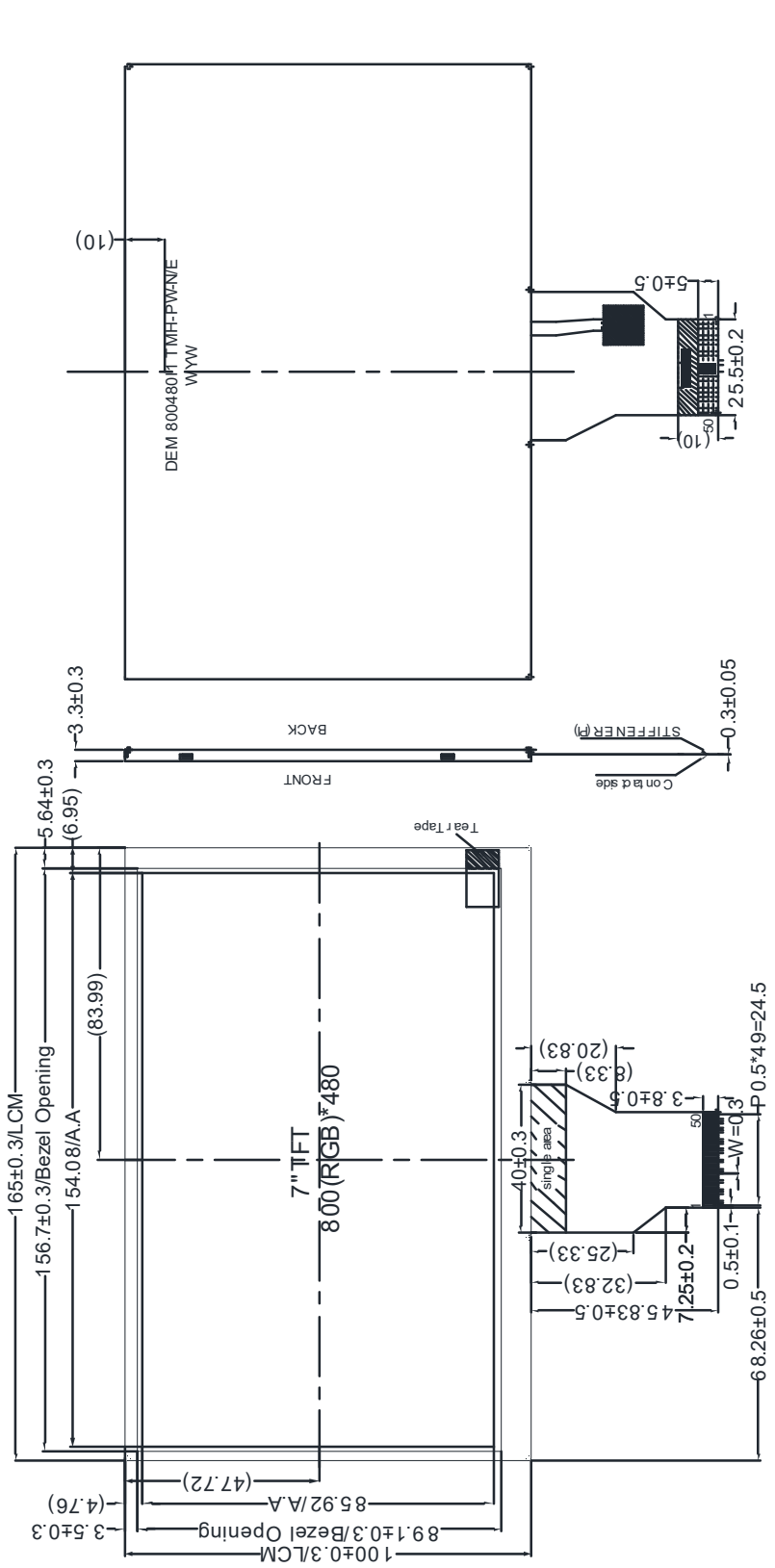
12.7. Limited Warranty

12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.

12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.

12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

13. Outline Drawing



PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL
1	LED-A	11	HS	21	G6	31	R4	41	VGH
2	LED-A	12	B7	22	G5	32	R3	42	VGL
3	LED-K	13	B6	23	G4	33	R2	43	AVDD
4	LED-K	14	B5	24	G3	34	R1	44	RESET
5	GND	15	B4	25	G2	35	R0	45	NC
6	VCOM	16	B3	26	G1	36	GND	46	VCOM
7	DVDD	17	B2	27	G0	37	DCLK	47	DITHB
8	MODE	18	B1	28	R7	38	GND	48	GND
9	DE	19	B0	29	R6	39	L/R	49	NC
10	VS	20	G7	30	R5	40	U/D	50	NC

Circuit Diagram (LED3X6=18)

NOTES:
1.Display size:7.0"TFT
2.Viewing direction:12 O'CLOCK
3.Gary Scale inversion direction:6 O'CLOCK
4.Display mode:Transmissive/Normal white/Anti-glare
5.Operation temperature:-20°C~+70°C
6.Storage temperature:-30°C~+80°C
7.Power supply voltage:3.3V
8.Driver IC:EK79713CA&EK73202AB2 /B
9.Backlight :White(18 LED)/9.6V(TYP)/120mA
10.Luminance:250cd/m²(TYP)
11.ROHS must be complied
* Unspecification tolerance are ± 0.2mm
* The dimension with mark brackets "()"just for reference